Device Modeling Report

COMPONENTS: OPERATIONAL AMPLIFIER (CMOS)

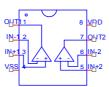
PART NUMBER: NJU7032

MANUFACTURER: NEW JAPAN RADIO



Bee Technologies Inc.

SPICE MODEL



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*$
*PART NUMBER: NJU7032
*MANUFACTURER: NEW JAPAN RADIO
*CMOS OPAMP
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.SUBCKT nju7032 IN-1 IN+1 IN-2 IN+2 VDD VSS OUT1 OUT2
X U1 IN-1 IN+1 VDD VSS OUT1 nju7032 s
X U2 IN-2 IN+2 VDD VSS OUT2 nju7032 s
.ENDS nju7032
*$
.SUBCKT nju7032 s
                   IN- IN+ VDD VSS OUT
M1
           2 IN-3 VDD MbreakPD3
M2
           2 IN+ 4 VDD MbreakPD2
           VDD 1 2 VDD MbreakPD
М3
           VDD 15 VDD MbreakPD
M4
           VDD 1 6 VDD MbreakPD
M5
M6
           VDD 1 1 VDD MbreakPD
           5 5 VSS VSS MbreakND W=3.2m
Μ7
                                           L=6u
           5 4 VSS VSS MbreakND3
M8
           3 3 IN1 VSS MbreakND1
М9
           4 3 IN2 VSS MbreakND1
M10
           1 6 11 11 MbreakND
M11
                                W=9m
                                         L=6u
M12
           6 6 VSS VSS MbreakND3
           7 5 VSS VSS MbreakND1
M13
           VDD 7 7 VDD MbreakPD
M14
M15
           VDD 7 OUT VDD MbreakPD1
           OUT 4 VSS VSS MbreakND2
M16
C1
          OUT IN- 10p
C2
          OUT 1 0.9p
C3
          OUT 3 45p
R1
           11 VSS 1.522k
R2
          IN1 VSS 2.0k
R3
          IN2 VSS 3.93k
11
          0 IN- 0.505p
12
          0 IN+ 1.5p
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X_U1 VSS 3 DbreakZ
```

X U2 VSS 4 DbreakZ

- .model MbreakND NMOS (LEVEL=3 VTO=0.9 RS=10.000E-3
- + RD=10.000E-3 RDS=1.0000E6 TOX=2.0000E-6 CGSO=4.000E-12
- + CGDO=1.000E-12 CBD=1.000E-12 RG=5 RB=1.0000E-3 KP=10E-6)
- .model MbreakND1 NMOS (LEVEL=3 L=6u W=0.5 VTO=1
- + RS=10.000E-3 RD=10.000E-3 RDS=1.0000E6 TOX=2.0000E-6
- + CGSO=1.00E-10 CGDO=1.000E-11 CBD=1.000E-10 RG=5
- + RB=1.0000E-3 KP=10E-6)
- .model MbreakND2 NMOS (LEVEL=3 L=6u W=0.483m VTO=0.9
- + RS=10.000E-3 RD=10.000E-3 RDS=1.0000E6 TOX=2.0000E-6
- + CGSO=4.000E-12 CGDO=1.00E-12 CBD=1.000E-12 RG=5
- + RB=1.0000E-3 KP=10E-6)
- .model MbreakND3 NMOS (LEVEL=3 L=6u W=3.2m VTO=0.9
- + RS=10.000E-3 RD=10.000E-3 RDS=1.0000E6 TOX=2.0000E-6
- + CGSO=1.000E-12 CGDO=1.000E-12 CBD=1.000E-12
- + RG=5 RB=1.0000E-3 KP=10E-6)
- .model MbreakPD PMOS (LEVEL=3 L=6u W=0.023 VTO=-1 RS=10.000E-3
- + RD=10.000E-3 RDS=1.0000E6 TOX=2.0000E-6 CGSO=4.000E-12
- + CGDO=1.000E-12 CBD=1.000E-12 RG=5 RB=1.0000E-3 KP=1E-6)
- .MODEL MbreakPD1 PMOS (LEVEL=3 L=6u W=0.0085 VTO=-0.9
- + RS=10.000E-3 RD=10.000E-3 RDS=1.00E6 TOX=2.0000E-6
- + CGSO=4.000E-12 CGDO=1.000E-12 CBD=1.000E-12
- + RG=5 RB=1.0000E-3 KP=1E-6)
- .MODEL MbreakPD2 PMOS (LEVEL=3 L=6u W=0.05 VTO=-1.4
- + RS=10.000E-3 RD=10.00E-3 RDS=1.2500E6 TOX=2.0000E-6
- + CGSO=4.000E-12 CGDO=1.000E-12 CBD=1.00E-12
- + RG=5 RB=1.0000E-3 KP=1E-6)
- .MODEL MbreakPD3 PMOS (LEVEL=3 L=6u W=0.0719 VTO=-1.4
- + RS=10.000E-3 RD=10.00E-3 RDS=1.E6 TOX=2.0000E-6
- + CGSO=4.000E-12 CGDO=1.000E-12 CBD=1.00E-12
- + RG=5 RB=1.0000E-3 KP=1E-6)
- .ENDS nju7032 s

.SUBCKT DbreakZ AK

D1 A K DF

DZ A2 A DR

VZ K A2 1

.MODEL DF D

.MODEL DR D

.ENDS DbreakZ

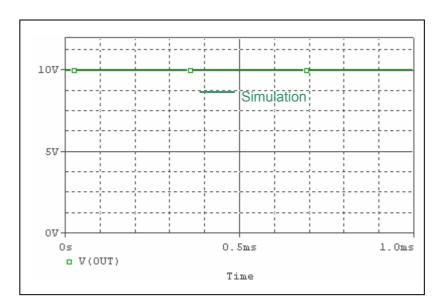
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MOSFET MODEL

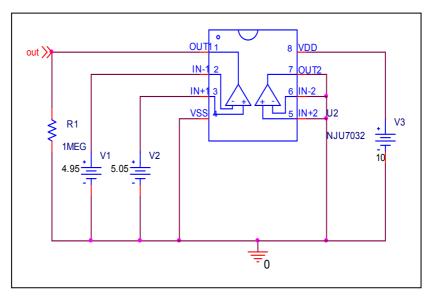
| Pspice model | Model description |
|--------------|--|
| parameter | • |
| LEVEL | |
| L | Channel Length |
| W | Channel Width |
| KP | Transconductance |
| RS | Source Ohmic Resistance |
| RD | Ohmic Drain Resistance |
| VTO | Zero-bias Threshold Voltage |
| RDS | Drain-Source Shunt Resistance |
| TOX | Gate Oxide Thickness |
| CGSO | Zero-bias Gate-Source Capacitance |
| CGDO | Zero-bias Gate-Drain Capacitance |
| CBD | Zero-bias Bulk-Drain Junction Capacitance |
| MJ | Bulk Junction Grading Coefficient |
| PB | Bulk Junction Potential |
| FC | Bulk Junction Forward-bias Capacitance Coefficient |
| RG | Gate Ohmic Resistance |
| IS | Bulk Junction Saturation Current |
| N | Bulk Junction Emission Coefficient |
| RB | Bulk Series Resistance |
| PHI | Surface Inversion Potential |
| GAMMA | Body-effect Parameter |
| DELTA | Width effect on Threshold Voltage |
| ETA | Static Feedback on Threshold Voltage |
| THETA | Modility Modulation |
| KAPPA | Saturation Field Factor |
| VMAX | Maximum Drift Velocity of Carriers |
| XJ | Metallurgical Junction Depth |
| UO | Surface Mobility |

Output Voltage Swing

Simulation result



Evaluation Circuit



V1 = (VDD/2) + 0.05,

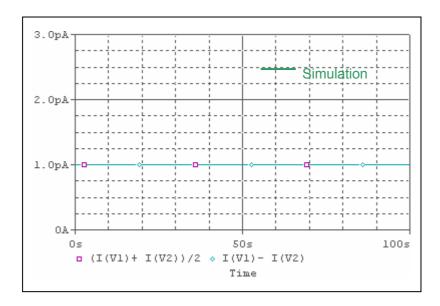
V2 = (VDD/2) - 0.05

Comparison Table

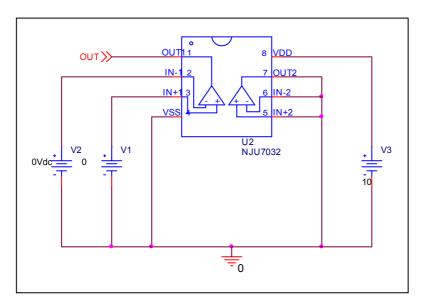
| | Measurement | Simulation | %Error |
|---------------------|-------------|------------|--------|
| V _{OM} (V) | 9.98 | 9.979 | -0.01 |

Input Current

Simulation result



Evaluation Circuit

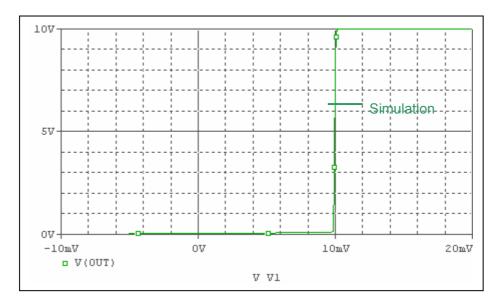


| | Measurement | Simulation | % Error |
|----------------------|-------------|------------|---------|
| I _b (pA) | 1 | 1.002 | 0.2 |
| I _{os} (pA) | 1 | 0.995 | -0.5 |

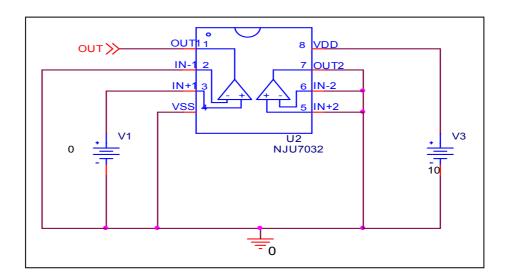
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Input Offset Voltage

Simulation result



Evaluation Circuit

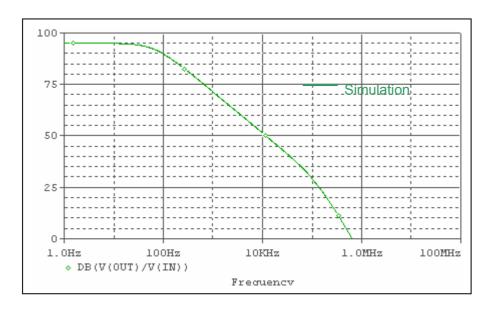


Comparison Table

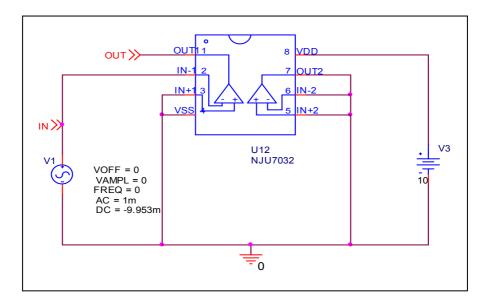
| | Measurement | Simulation | %Error |
|----------------------|-------------|------------|--------|
| V _{OS} (mV) | 10 | 9.953 | -0.47 |

Open loop Voltage Gain

Simulation result



Evaluation Circuit

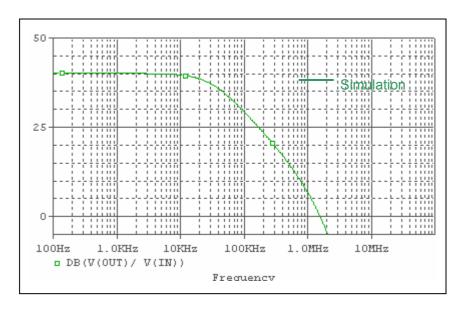


Comparison Table

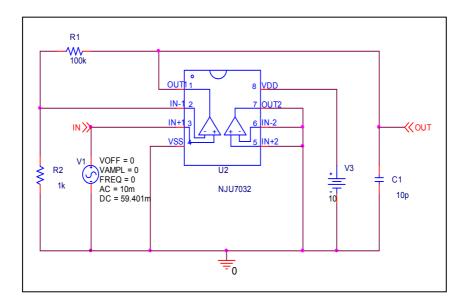
| | Measurement | Simulation | %Error |
|---------|-------------|------------|--------|
| Av (dB) | 95 | 95.043 | 0.045 |

Unity Gain Frequency

Simulation result



Evaluation Circuit



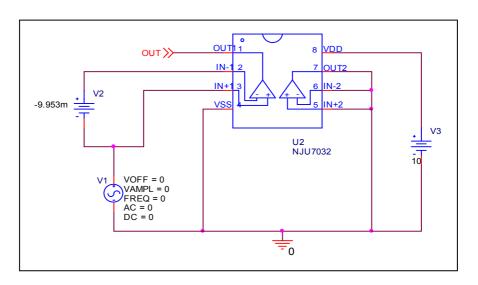
| A _V =40dB,C _L =10pF | Measurement | Simulation | %Error |
|---|-------------|------------|--------|
| Ft(MHz) | 1.5 | 1.56 | 4 |

Common-Mode Rejection Ratio

Simulation result



Evaluation Circuit

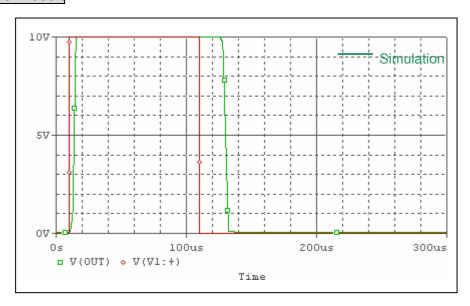


CMRR= AV / ACM

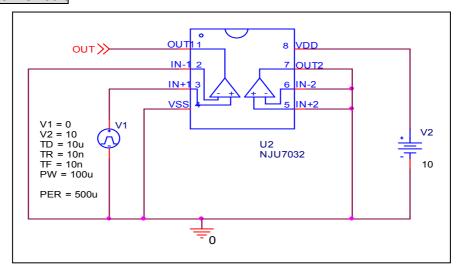
| | Measurement | Simulation | %Error |
|-----------|-------------|------------|--------|
| CMRR (dB) | 75 | 72 | -4 |

Slew Rate

Simulation result



Evaluation Circuit



| | Measurement | Simulation | % Error |
|-----------|-------------|------------|---------|
| SR (V/us) | 3.5 | 3.52 | 0.571 |